MICROWAVE POWER GaAs FET

Low Distortion Internally Matched Power GaAs FETs (C-Band)

Features

- · Low intermodulation distortion
 - $IM_3 = -45 \text{ dBc}$ at Po = 34.5 dBm,
 - Single carrier level
- · High power
 - P_{1dB} = 45 dBm at 5.3 GHz to 5.9 GHz
- High gain
 - $G_{1dB} = 8.5 dB$ at 5.3 GHz to 5.9 GHz
- · Broad band internally matched
- · Hermetically sealed package

RF Performance Specifications (Ta = 25° C)

Characteristics	Symbol	Condition	Unit	Min.	Тур.	Max
Output Power at 1dB Compression Point	P _{1dB}		dBm	44.0	45.0	_
Power Gain at 1dB Compression Point	G _{1dB}	V _{DS} = 10V	dB	7.5	8.5	-
Drain Current	I _{DS1}	f = 5.3 ~ 5.9 GHz	Α	_	8.0	9.0
Gain Flatness	ΔG		dB	_	_	±0.8
Power Added Efficiency	η _{add}		%	_	34	_
3rd Order Intermodulation Distortion	IM ₃	Note 1	dBc	-42	-45	_
Drain Current	I _{DS2}	14016 1	Α	_	8.0	9.0
Channel-Temperature Rise	nnel-Temperature Rise ΔT_{ch}		°C	_	_	80

Electrical Characteristics (Ta = 25° C)

Characteristic	Symbol	Condition	Unit	Min.	Тур.	Max
Trans-conductance	gm	$V_{DS} = 3V$ $I_{DS} = 10.5A$	mS	_	6300	-
Pinch-off Voltage	V _{GSoff}	$V_{DS} = 3V$ $I_{DS} = 140 \text{mA}$	V	-2	-3.5	-5.0
Saturated Drain Current	I _{DSS}	$V_{DS} = 3V$ $V_{GS} = 0V$	А	-	20	26
Gate-Source Breakdown Voltage	V_{GSO}	$I_{GS} = -420 \mu A$	V	-5	_	_
Thermal Resistance	R _{th (c-c)}	Channel to case	°C/W	-	0.8	1.0

Note 1: 2 tone Test Pout = 34.5dBm Single Carrier Level.

The information contained here is subject to change without notice.

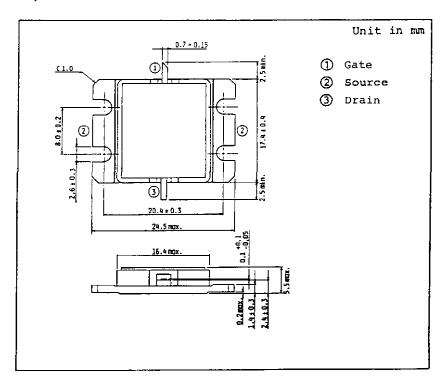
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Absolute Maximum Ratings (Ta = 25° C)

Characteristic	Symbol	Unit	Rating
Drain-Source Voltage	V _{DS}	V	15
Gate-Source Voltage	V _{GS}	V	-5
Drain Current	I _{DS}	А	26
Total Power Dissipation (T _c = 25°C)	P _T	W	120
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

Package Outline (2-16G1B)



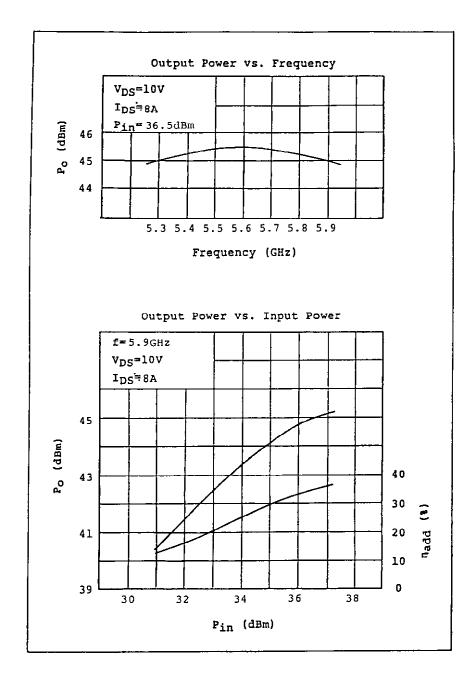
Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

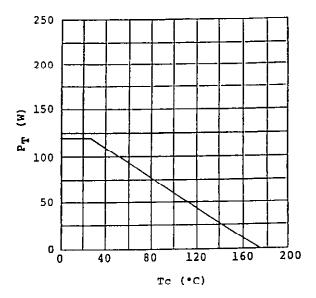
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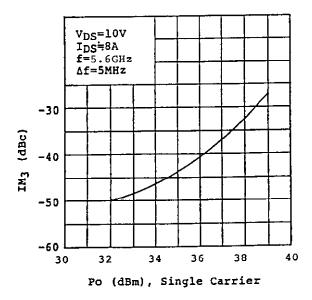
RF Performances



Power Dissipation vs. Case Temperature



IM₃ vs. Output Power Characteristics

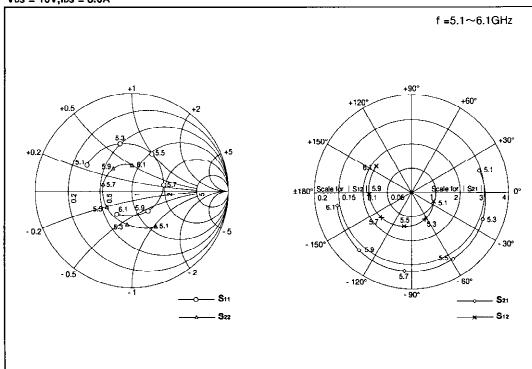


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TIM5359-30L S-Parameters (MAGN. and ANGLES)

Vos = 10V,los = 8.0A



FREQUENCY	S ₁₁		S ₁₂		S ₂₁		S 22	
(MHz)	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
5.1	0.537	149.9	0.048	-21.2	2.971	18.3	0.446	-55.3
5.3	0.503	104.0	0.061	-64.2	3.164	-20.1	0.347	-98.3
5.5	0.436	59.9	0.072	-103.9	3.250	-57.8	0.307	-147.3
5.7	0.346	11.8	0.082	-141.7	3.260	-95.0	0.310	167.5
5.9	0.273	-48.4	0.090	-178.8	3.223	-132.3	0.305	128.8
6.1	0.275	-121.1	0.093	143.8	3.125	-170.4	0.264	89.8
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